# BGA616 Silicon Germanium Broadband MMIC Amplifier

**RF & Protection Devices** 



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#### BGA616, Silicon Germanium Broadband MMIC Amplifier

Revision History: 2011-09-02, Rev. 2.1

Previous Version: 2003-04-16					
Page	Subjects (major changes since last revision)				
All	New Chip Version with integrated ESD protection				
5	Electrical Characteristics slightly changed				
7-8	Figures updated				
All	Document layout change				

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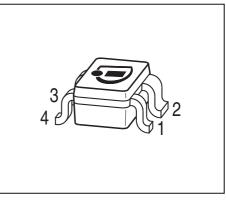
Silicon Germanium Broadband MMIC Amplifier

# 1 Silicon Germanium Broadband MMIC Amplifier

#### Feature

- Cascadable 50 Ω-gain block
- 3 dB-bandwidth: DC to 2.7 GHz with 19.0 dB typical gain at 1.0 GHz
- Compression point P<sub>-1dB</sub> = 18 dBm at 2.0 GHz
- Noise figure  $F_{50\Omega}$  = 2.60 dB at 2.0 GHz
- Absolute stable
- 70 GHz  $f_{\rm T}$  Silicon Germanium technology
- 1 kV HBM ESD protection (Pin-to-Pin)
- Pb-free (RoHS compliant) package





SOT343

#### Applications

- Driver amplifier for GSM/PCS/SCDMA/UMTS
- Broadband amplifier for SAT-TV & LNBs
- Broadband amplifier for CATV

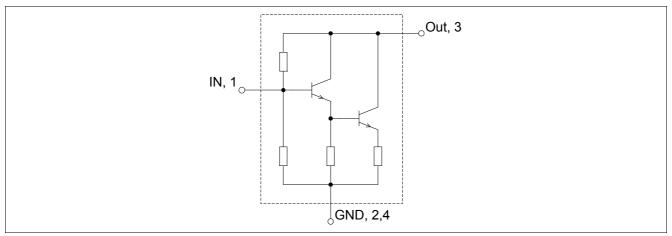


Figure 1 Pin connection

#### Description

The BGA616 is a broadband matched general purpose MMIC amplifier in a Darlington configuration. It is optimized for a typical supply current of 60 mA.

The BGA616 is based on Infineon Technologies' B7HF Silicon Germanium technology.

Туре	Package	Marking
BGA616	SOT343	BPs

Note: ESD: Electrostatic discharge sensitive device, observe handling precaution



#### **Electrical Characteristics**

#### **Maximum Ratings**

#### Table 1 Maximum ratings

Parameter	Symbol	Limit Value	Unit	
Device voltage	VD	4.5	V	
Device current	ID	80	mA	
Current into pin In	I <sub>in</sub>	0.7	mA	
Input power <sup>1)</sup>	$P_{\rm in}$	10	dBm	
Total power dissipation, $T_{\rm S}$ < 78 °C <sup>2)</sup>	P <sub>tot</sub>	360	mW	
Junction temperature	T <sub>J</sub>	150	°C	
Ambient temperature range	T <sub>A</sub>	-65 150	°C	
Storage temperature range	$T_{\rm STG}$	-65 150	°C	
ESD capability all pins (HBM: JESD22-A114)	V <sub>ESD</sub>	1000	V	
	1		1	

1) Valid for  $Z_{\rm S}$  =  $Z_{\rm L}$  = 50  $\Omega$ ,  $V_{\rm CC}$  = 6 V,  $R_{\rm Bias}$  = 33  $\Omega$ 

2)  $T_{\rm S}$  is measured on the ground lead at the soldering point

Note: All Voltages refer to GND-Node

#### Thermal resistance

#### Table 2Thermal resistance

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	R <sub>thJS</sub>	200	K/W

1) For calculation of  $R_{\rm thJA}$  please refer to Application Note Thermal Resistance

## 2 Electrical Characteristics

Electrical characteristics at  $T_A$  = 25 °C (measured in test circuit specified in Figure 2)  $V_{CC}$  = 6 V,  $R_{Bias}$  = 33  $\Omega$ , Frequency = 2 GHz, unless otherwise specified

#### Table 3 Electrical Characteristics

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		<b>Test Condition</b>
Insertion power gain	$ S_{21} ^2$		20.0		dB	<i>f</i> = 0.1 GHz
			19.0		dB	<i>f</i> = 1 GHz
			18.0		dB	<i>f</i> = 2 GHz
Noise figure ( $Z_{\rm S}$ = 50 $\Omega$ )	$F_{50\Omega}$		2.2		dB	<i>f</i> = 0.1 GHz
			2.5		dB	<i>f</i> = 1 GHz
			2.6		dB	<i>f</i> = 2 GHz
Output power at 1 dB gain compression	P <sub>-1dB</sub>		18		dBm	
Output third order intercept point	OIP <sub>3</sub>		29		dBm	
Input return loss	<i>RL</i> <sub>in</sub>		15		dB	
Output return loss	<i>RL</i> <sub>out</sub>		15		dB	
Total device current	ID		60		mA	



### **BGA616**

#### **Electrical Characteristics**

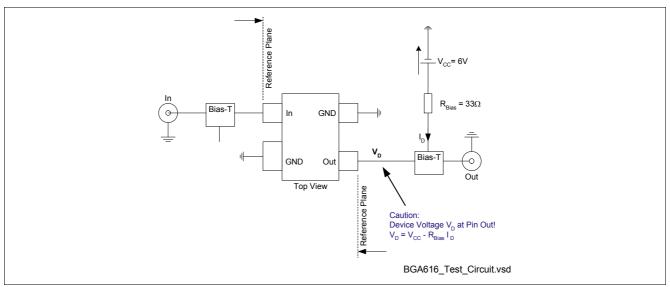


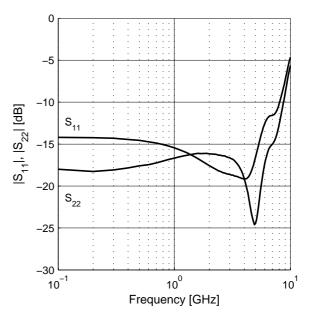
Figure 2 Test Circuit for Electrical Characteristics and S-Parameter



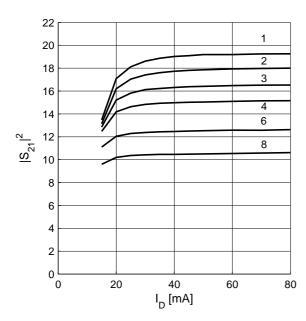
## 3 Measured Parameters

Power Gain  $|S_{21}|^2$ ,  $G_{ma} = f(f)$  $V_{CC} = 6V$ ,  $R_{Bias} = 33\Omega$ ,  $I_C = 60mA$ 22 G<sub>ma</sub> 20 ||S<sub>21</sub>|<sup>2</sup> 18 16 |S<sub>21</sub>|<sup>2</sup>, G<sub>ma</sub> [dB] 14 12 10 8 6 4 2 0 10<sup>-1</sup> 10<sup>0</sup> 10<sup>1</sup> Frequency [GHz]

 $\begin{array}{l} \textbf{Matching} \; |S_{11}|, \; |S_{22}| = f(f) \\ \textbf{V}_{CC} = 6 \textbf{V}, \; \textbf{R}_{Bias} = 33 \Omega, \; \textbf{I}_{C} = 60 \textbf{mA} \end{array}$ 

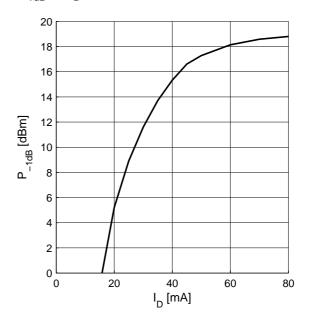


**Power Gain**  $|S_{21}| = f(I_D)$ f = parameter in GHz



**Output Compression Point** 

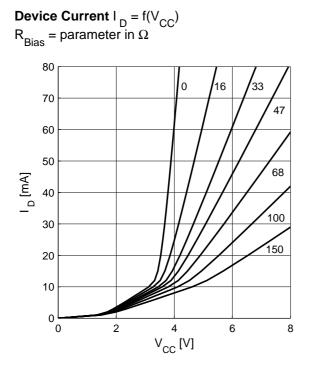
 $P_{-1dB} = f(I_D), f = 2GHz$ 



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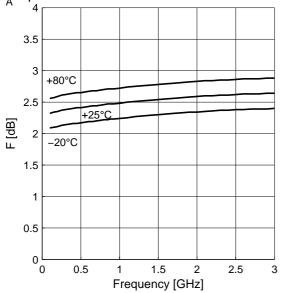


#### **Measured Parameters**



Device Current I  $_{D} = f(T_{A})$ V<sub>CC</sub> = 6V, R<sub>Bias</sub> = parameter in  $\Omega$ 80 75 70 30 65 I <sub>D</sub> [mA] 33 60 36 55 50 45 40 L -40 -20 0 20 40 60 80 T<sub>A</sub> [°C]

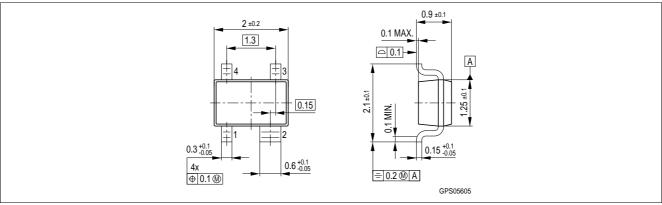
Noise figure F = f(f)  $V_{CC} = 6V, R_{Bias} = 33\Omega, Z_{S} = 50\Omega$  $T_{A} = parameter in °C$ 



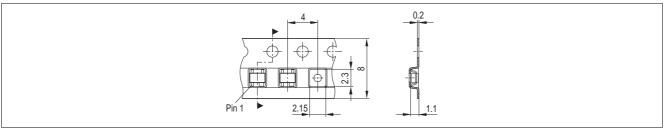


**Package Information** 

# 4 Package Information



## Figure 3 Package Outline SOT343



#### Figure 4 Tape for SOT343

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